NOT RECOMMENDED FOR NEW DESIGN USE SBR12U45LH1



SBR12U45LH

12A SBR SUPER BARRIER RECTIFIER POWERDISSP

Product Summary

V _{RRM} (V)	I _O (A)	V _{F(typ)} @ +125°C (V)	I _{R(MAX)} @ V _{RRM} (mA)
45	12	0.38	0.3

Description

The SBR12U45LH uses SBR $^{\otimes}$ patented technology that offers ultralow V_F to reduce forward power loss and improve efficiency. Encapsulated in the new PDI-5SP package with a 0.75mm low height profile and protruding leads for easy soldering, it is especially suited for use as a bypass diode in solar panels.

Applications

Solar Bypass Diode

Features

- Designed as bypass diodes for solar panels
- Low profile height (0.75mm) and 9mm protruding leads, enabling the package to be integrated within the solar glass panel
- Selectively rated for +200°C maximum junction temperature for high thermal reliability and excellent high temperature stability
- Patented Super Barrier Rectifier technology
- Ultra low forward voltage drop to minimize forward power losses
- Very low reverse leakage to ensures maximum efficiency of solar panel
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Mechanical Data

- Case: POWERDI[®]5SP
- Case Material: Molded Plastic, UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Polarity: Cathode bar mark on top and cathode notch on lead
- Weight: 0.199 grams (Approximate)





Top View

Pin Configuration

Ordering Information (Note 4)

Part Number	Case	Packaging
SBR12U45LH-13	POWERDI5SP	3,500 Tape & Reel

Notes: 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.

- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.



Marking Information



SBR12U45 = Product Type Marking Code

J'!= Manufacturers' Code Marking

YYWWK = Date Code Marking

YY = Last Two Digits of Year (ex: 14 for 2014)

WW = Week Code (01 ~ 53)

K = Factory Designator

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _{RM}	45	V
Average Rectified Output Current	lo	12	Α
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I _{FSM}	300	А

Thermal Characteristics

Chara	cteristic	Symbol	Value	Unit
Typical Thermal Resistance Junction to Ambient (Note 5)		R _{θJA}	66	°C/W
Operating Temperature Range	V _R ≤ 80% V _{RRM}	T_J	-65 to +150	°C
	DC Forward Mode (Note 7)	τ _ν	≤200	°C
Storage Temperature Range		T _{STG}	-65 to +175	°C

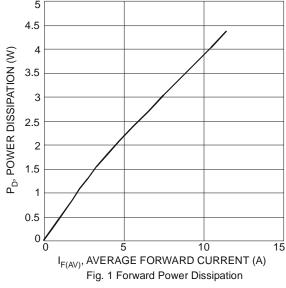
Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

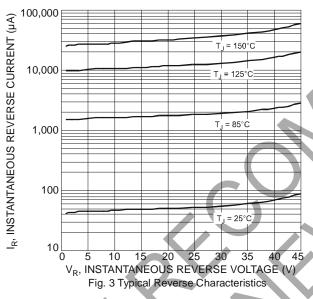
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
	·		0.40	0.48	V	$I_F = 10A, T_J = +25$ °C
Forward Voltage Drop	VF	_	0.42	0.50		I _F = 12A, T _J = +25°C
		_	0.38	0.45		I _F = 12A, T _J = +125°C
		— 70 200A	$V_R = 40V, T_J = +25^{\circ}C$			
Leakage Current (Note 6)		_	90	300	μΑ	V _R = 45V, T _J = +25°C
Leakage Current (Note 6)	I _R	_	19	_	A	V _R = 45V, T _J = +125°C
		1	60	_	mA	V _R = 45V, T _J = +150°C

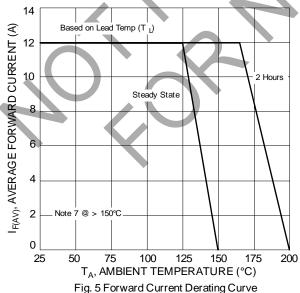
Notes:

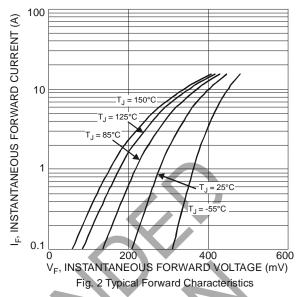
- 5. FR-4 PCB, 2oz. Copper, minimum recommended pad layout per http://www.diodes.com.pdf.
- 6. Short duration pulse test used to minimize self-heating effect.
- 7. Max junction temperature +200°C guaranteed for 2 hours at maximum output.

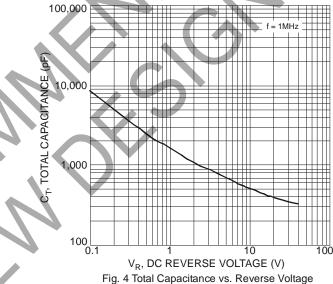


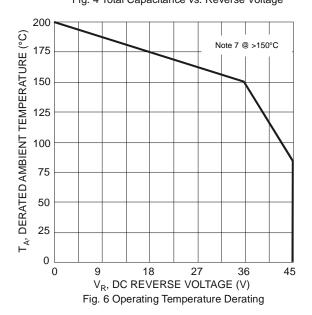










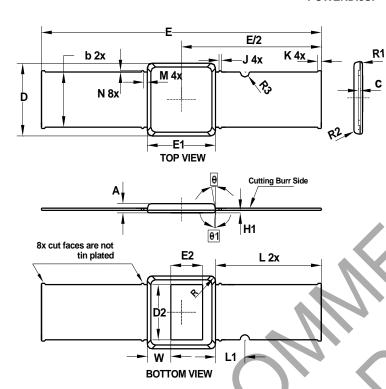




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

POWERDISSP

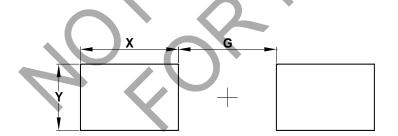


POWERDI5SP					
Dim	Min	Max	Тур		
Α	-	0.75	-		
b	4.30	4.50	4.40		
С	0.155	0.195	-		
D	5.70	5.90	5.80		
D2	4.40	-	-		
Е	23.6	24.0	23.8		
E1	5.70	5.90	5.80		
E2	2.74	-	-		
H1	0.19	0.21	0.20		
۲	-	-	0.20		
K	-	-	0.30		
Ĺ	-		9.00		
L1	.(1	2.50		
M	(1	0.30		
Ν	0	0.20	-		
R	-	-	0.40		
R1	1		0.15		
R2	-	-	0.25		
R3		-	0.40		
W	1.66	2.06	-		
θ	8°	12°	-		
θ1	3°	7°	-		
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.





Dimensions	Value (in mm)		
G	8.101		
Х	8.100		
Υ	5.100		





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